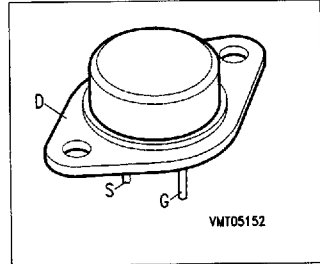


SIPMOS® Power Transistor

BUZ 15

- N channel
- Enhancement mode
- Avalanche-rated



Type	V_{DS}	I_D	$R_{DS(on)}$	Package ¹⁾	Ordering Code
BUZ 15	50 V	45 A	0.03 Ω	TO-204 AE	C67078-S1001-A2

Maximum Ratings

Parameter	Symbol	Values	Unit
Continuous drain current, $T_C = 28^\circ\text{C}$	I_D	45	A
Pulsed drain current, $T_C = 25^\circ\text{C}$	$I_{D(puls)}$	180	
Avalanche current, limited by $T_{j(max)}$	I_{AR}	45	
Avalanche energy, periodic limited by $T_{j(max)}$	E_{AR}	2.5	mJ
Avalanche energy, single pulse $I_D = 42\text{ A}$, $V_{DD} = 25\text{ V}$, $R_{GS} = 25\ \Omega$ $L = 20.2\ \mu\text{H}$, $T_j = 25^\circ\text{C}$	E_{AS}	41	
Gate-source voltage	V_{GS}	± 20	V
Power dissipation, $T_C = 25^\circ\text{C}$	P_{tot}	125	W
Operating and storage temperature range	T_j, T_{stg}	- 55 ... + 150	$^\circ\text{C}$
Thermal resistance, chip-case	$R_{th(JC)}$	≤ 1.0	K/W
DIN humidity category, DIN 40 040	—	C	—
IEC climatic category, DIN IEC 68-1	—	55/150/56	—

1) See chapter Package Outlines.

Electrical Characteristics

at $T_j = 25\text{ °C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static characteristics

Drain-source breakdown voltage $V_{GS} = 0\text{ V}, I_D = 0.25\text{ mA}$	$V_{(BR)DSS}$	50	–	–	V
Gate threshold voltage $V_{GS} = V_{DS}, I_D = 1\text{ mA}$	$V_{GS(th)}$	2.1	3.0	4.0	
Zero gate voltage drain current $V_{DS} = 50\text{ V}, V_{GS} = 0\text{ V}$ $T_j = 25\text{ °C}$ $T_j = 125\text{ °C}$	I_{DSS}	– –	0.1 10	1.0 100	μA
Gate-source leakage current $V_{GS} = 20\text{ V}, V_{DS} = 0\text{ V}$	I_{GSS}	–	10	100	nA
Drain-source on-resistance $V_{GS} = 10\text{ V}, I_D = 29\text{ A}$	$R_{DS(on)}$	–	0.025	0.030	Ω

Dynamic characteristics

Forward transconductance $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}, I_D = 29\text{ A}$	g_{fs}	7.0	22.0	–	S
Input capacitance $V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	C_{iss}	–	1800	2400	pF
Output capacitance $V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	C_{oss}	–	800	1200	
Reverse transfer capacitance $V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	C_{rss}	–	280	450	
Turn-on time t_{on} , ($t_{on} = t_{d(on)} + t_r$) $V_{DD} = 30\text{ V}, V_{GS} = 10\text{ V}, I_D = 3\text{ A}, R_{GS} = 50\text{ }\Omega$	$t_{d(on)}$	–	35	50	ns
	t_r	–	85	130	
Turn-off time t_{off} , ($t_{off} = t_{d(off)} + t_f$) $V_{DD} = 30\text{ V}, V_{GS} = 10\text{ V}, I_D = 3\text{ A}, R_{GS} = 50\text{ }\Omega$	$t_{d(off)}$	–	220	280	
	t_f	–	140	180	

Electrical Characteristics (cont'd)at $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

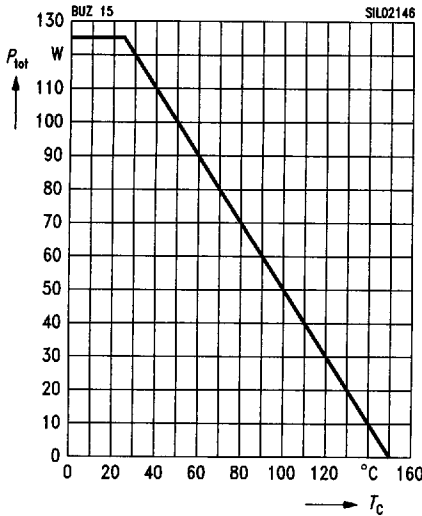
Reverse diode

Continuous reverse drain current $T_C = 25\text{ }^\circ\text{C}$	I_S	–	–	45	A
Pulsed reverse drain current $T_C = 25\text{ }^\circ\text{C}$	I_{SM}	–	–	180	
Diode forward on-voltage $I_S = 90\text{ A}$, $V_{GS} = 0\text{ V}$	V_{SD}	–	1.8	2.2	V
Reverse recovery time $V_R = 30\text{ V}$, $I_F = I_S$, $di_F / dt = 100\text{ A}/\mu\text{s}$	t_{rr}	–	80	–	ns
Reverse recovery charge $V_R = 30\text{ V}$, $I_F = I_S$, $di_F / dt = 100\text{ A}/\mu\text{s}$	Q_{rr}	–	0.14	–	μC

Characteristics at $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified.

Total power dissipation

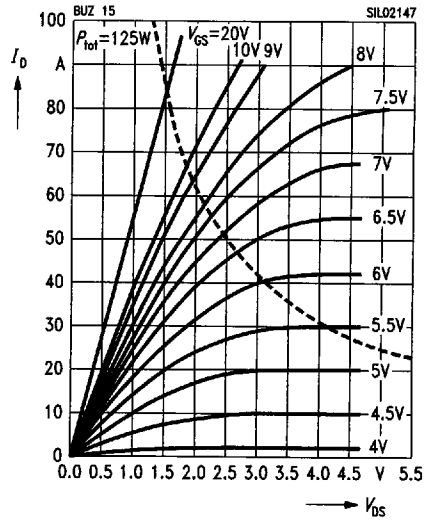
$$P_{\text{tot}} = f(T_C)$$



Typ. output characteristics

$$I_D = f(V_{DS})$$

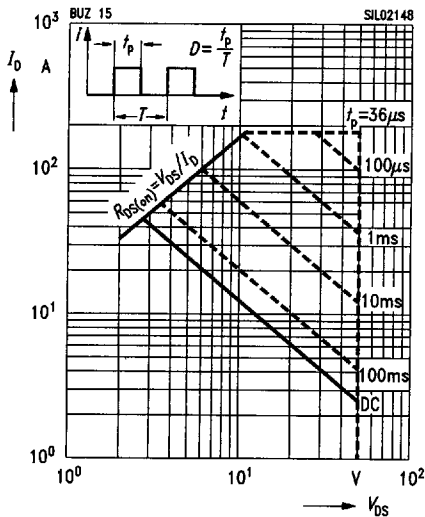
parameter: $t_p = 80\text{ }\mu\text{s}$



Safe operating area

$$I_D = f(V_{DS})$$

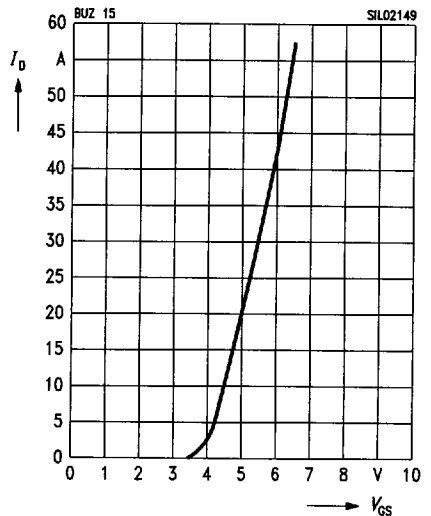
parameter: $D = 0.01$, $T_C = 25\text{ }^\circ\text{C}$



Typ. transfer characteristics

$$I_D = f(V_{GS})$$

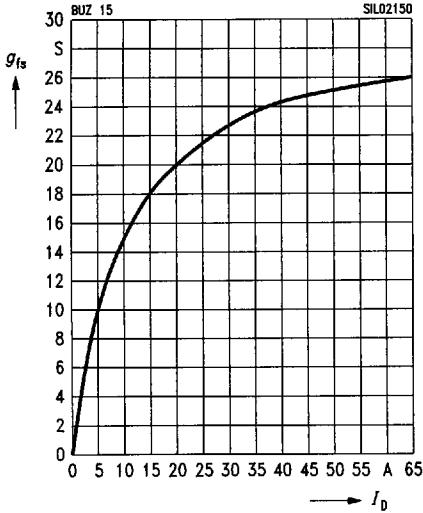
parameter: $t_p = 80\text{ }\mu\text{s}$, $V_{DS} = 25\text{ V}$



Typ. forward transconductance

$g_{fs} = f(I_D)$

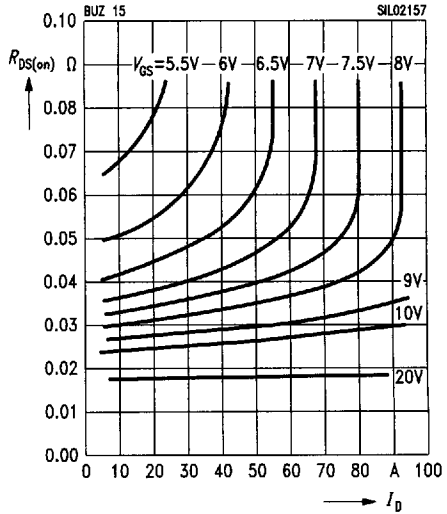
parameter: $t_p = 80 \mu s$



Typ. drain-source on-resistance

$R_{DS(on)} = f(I_D)$

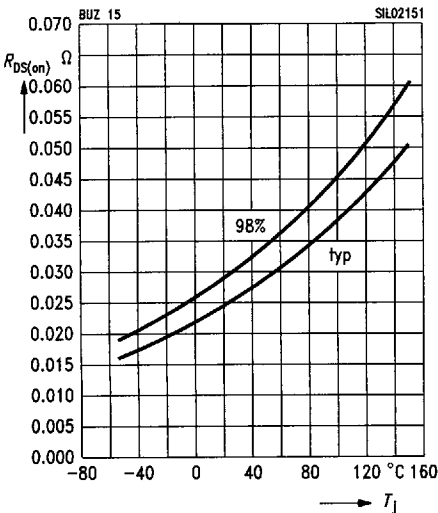
parameter: V_{GS}



Drain-source on-resistance

$R_{DS(on)} = f(T_J)$

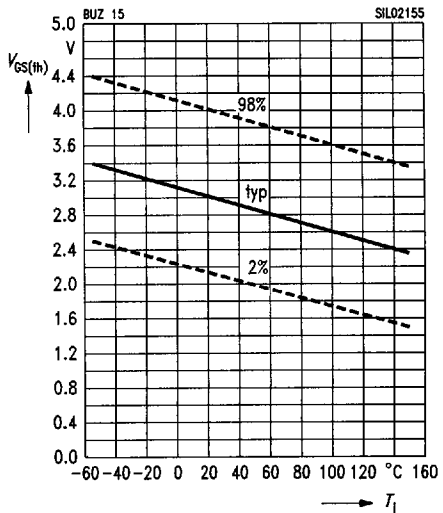
parameter: $I_D = 29 A, V_{GS} = 10 V, (\text{spread})$



Gate threshold voltage

$V_{GS(th)} = f(T_J)$

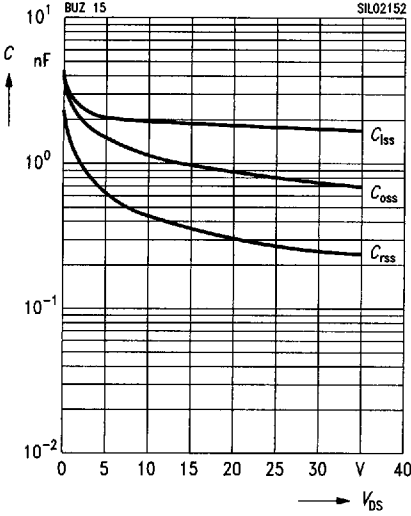
parameter: $V_{GS} = V_{DS}, I_D = 1 mA, (\text{spread})$



Typ. capacitances

$C = f(V_{DS})$

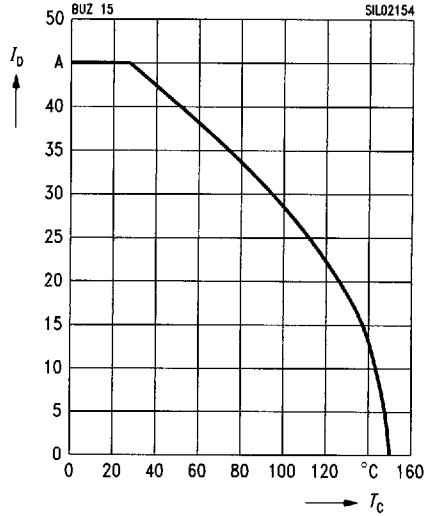
parameter: $V_{GS} = 0\text{ V}$, $f = 1\text{ MHz}$



Drain current

$I_D = f(T_C)$

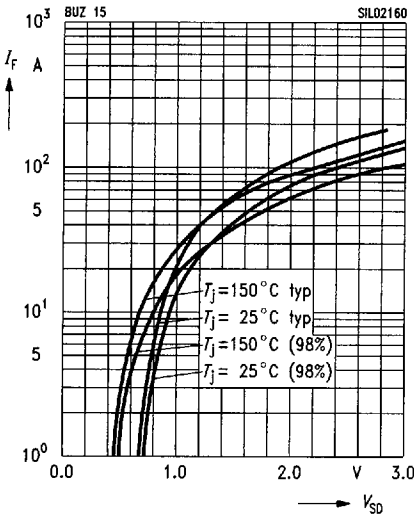
parameter: $V_{GS} \geq 10\text{ V}$



Forward characteristics of reverse diode

$I_F = f(V_{SD})$

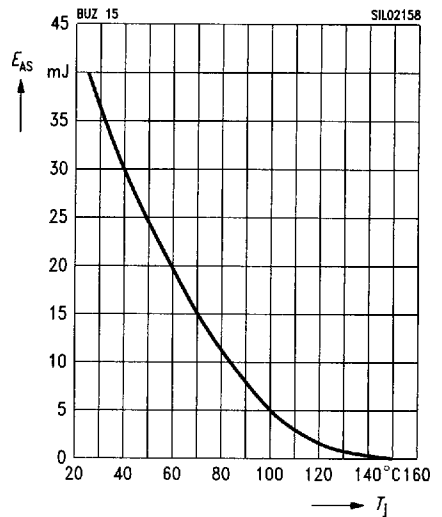
parameter: T_j , $t_p = 80\ \mu\text{s}$, (spread)



Avalanche energy $E_{AS} = f(T_j)$

parameter: $I_D = 45\text{ A}$, $V_{DD} = 25\text{ V}$

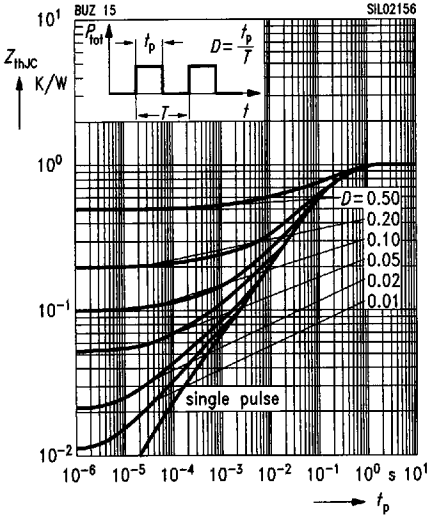
$R_{GS} = 25\ \Omega$, $L = 20.2\ \mu\text{H}$



Transient thermal impedance

$Z_{th,JC} = f(t_p)$

parameter: $D = t_p / T$



Typ. gate charge

$V_{GS} = f(Q_{Gate})$

parameter: $I_{D\ puls} = 63.0\ A$

